

Mini-Circuits

### 50Ω 1150 to 8000 MHz

### THE BIG DEAL

- Insertion Loss, 0.5 dB Typ.
- Stop Band Rejection, 47 dB Typ.
- Pass Band Return Loss, 11 dB Typ.
- 0805 Surface Mount Footprint
- Power Handling: 3 W

### **APPLICATIONS**

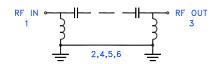
- Test & Measurement Equipment
- Radar, EW, and ECM Defense System
- 5G MIMO and Back Haul Radio
- 5G Sub 6GHz and WiFi 6E



HFCG-1000+

Generic photo used for illustration purposes only

### **FUNCTIONAL DIAGRAM**



### **PRODUCT OVERVIEW**

Mini-Circuits' HFCG-1000+ is a miniature low temperature co-fired ceramic (LTCC) high pass filter with a 1150 to 8000 MHz passband that supports a variety of applications. This model provides 0.5 dB typical insertion loss over a wide band due to its rugged monolithic construction. Housed in a tiny 0805 ceramic form factor which is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

### **KEY FEATURES**

Features	Advantages
Wide Passband, 6.85 GHz	This filter has a very wide passband, from 1150 to 8000 MHz.
LTCC Construction	The use of LTCC technology allows for repeatable performance in a rugged ceramic package, well suited for tough environments such as high humidity and temperature extremes. See Mini-Circuits Environmental Rating ENV06T11 for more informatio.
Small Size, 0805	0805 package allows for space to be saved in dense circuit board layouts, while also minimizing the effects of parasitics.
Rugged Power Handling, 3 W	Handles up to 3 Watts in a small 0805 package.

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LTCC SURFACE MOUNT

### ligh Pass Filter ľ

Mini-Circuits

#### 1150 to 8000 MHz 50Ω

ELECTRICAL SPECIFICATIONS <sup>1,2,3</sup> AT +25°C							
Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Units
Passband		F3-F4	1150 - 2000	_	1.8	_	
	Insertion Loss	F4-F5	2000 - 6500	_	0.5	1.1	dB
		F5-F6	6500 - 8000	_	0.7	1.3	
	Return Loss	F3-F4	1150 - 2000	_	8	_	
		F4-F5	2000 - 6500	_	11	_	dB
		F5-F6	6500 - 8000	_	15	_	
Stopband	Rejection	DC-F1	DC - 600	41	47	_	
		F1-F2	600 - 780	20	35	_	dB
	Freq. Cut-Off <sup>4</sup>	Fc	1000	_	3	_	

1. Tested on Evaluation Board P/N TB-HFCG-1000+.

2. Bi-directional RF1 and RF2 ports can be interchanged .

This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.

4. Typical variation ±5%.

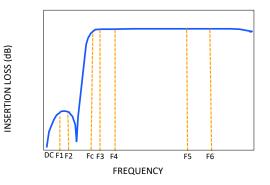
### **ABSOLUTE MAXIMUM RATINGS<sup>5</sup>**

Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power <sup>6</sup>	3 W @ +25°C

5. Permanent damage may occur if any of these limits are exceeded.

6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.7 W at +125°C.

### **TYPICAL FREQUENCY RESPONSE AT +25°C**



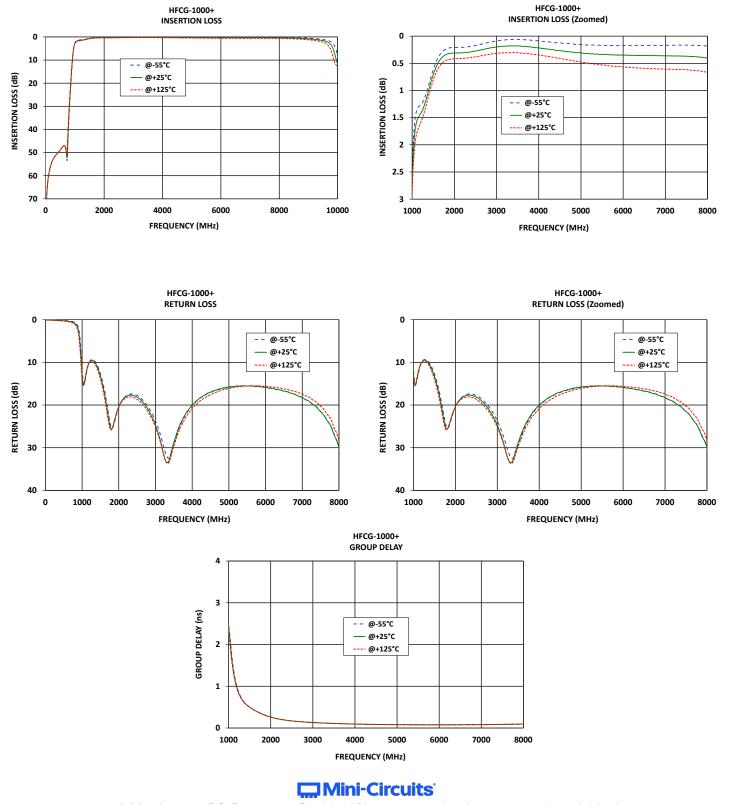


## HFCG-1000+

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### **TYPICAL PERFORMANCE GRAPHS**





# High Pass Filter

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### **FUNCTIONAL DIAGRAM**

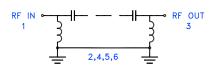


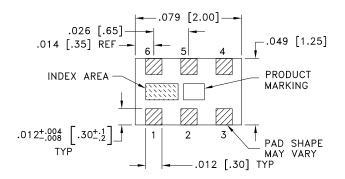
Figure 1. HFCG-1000+ Functional Diagram

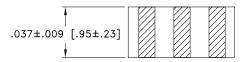
### **PAD DESCRIPTION**

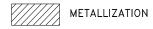
Function	Pad Number	Description
RF1 <sup>2</sup>	1	Connects to RF Input Port
RF2 <sup>2</sup>	3	Connects to RF Output Port
GROUND	2,4,5,6	Connects to Ground on PCB, (See drawing PL-633)

### **CASE STYLE DRAWING**

**HFCG-1000+** 







Weight: .008 grams.

Dimensions are in inches (mm). Tolerances:  $2Pl. \pm .01$ ;  $3Pl. \pm .005$ 

### **PRODUCT MARKING\*: XS**

\*Marking may contain other features or characters for internal lot control.

### NDEX NDEX \*.013 PTH TYP 4x.026±.002 SPACE WIDTH .019 2x.043±.002 TRACE WIDTH PACKAGE OUTLINE .010 -.018

SUGGESTED PCB LAYOUT (PL-633)

NOTES:

 COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .020±.0015. COPPER: 1/2 0Z. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Figure 2. Suggested PCB Layout PL-633



### LTCC SURFACE MOUNT

## High Pass Filter



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### ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

**CLICK HERE** 

	Data
Performance Data and Graphs	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	GE0805C-9 Lead Finish: Tin over Nickel Plating
RoHS Status	Compliant
Tape and Reel	F114
Suggested Layout for PCB Design	PL-633
Evaluation Board	TB-HFCG-1000+
	Gerber File
Environmental Rating	ENV06T11

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

